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### Dimensions

Chip Size	1812
L	4.52mm +/-0.3mm (0.178 in +/-0.012 in)
W	3.2mm +/-0.3mm (0.126 in +/-0.012 in)
T	2.79mm MAX (0.11 in MAX)
B	0.61mm +/-0.46mm (0.024 in +/-0.018 in)

### Packaging Specifications

Packaging	Waffle
Packaging Quantity	368

### General Information

Series	SMD MIL X7R PRF32535
Style	SMD Chip
Description	SMD, Low ESR, MIL-PRF-32535
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
Termination	Flexible Termination
Qualifications	MIL-PRF-32535 T-Level
AEC-Q200	No
Component Weight	216 mg
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	1 uF
Capacitance Tolerance	10%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	1 GOhms

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